## SENKO® + Fiber III Advanced Components + Fiber III LATIN AMERICA CHAPTER

#### Evaluating Duplex and Multi-fiber Connectivity in a Rapidly Evolving Network Landscape

July 25, 2024

#### Leading the Fiber Optic Revolution

Top 2 global share passive optical connectivity
1+ billion connectors deployed globally
\$300 million global sales/year

590 patents granted globally
90+ VSFF patents globally
Connectivity that spans entire network

Years in

**Fiber Optic** 



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#### **Diverse Market Presence**



#### TELECOM Data Centers INDUSTRIAL SILICON PHOTONICS WIRELESS Automotive Hyperscale MEDICAL On-Board Optics SECURITY FTTX AVIATION and more...



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#### **Connectivity Spanning the Network**



**Evolution** 

**Revolution** 



## **Current Market Status**

#### Network congestion, densification and complexity



**Network** Drive Toward Sustainability







#### **Data Rate Trends**

Annual Sales (\$mn)

800G is starting in 2024

SENKO connectivity is driving nextgeneration applications that consume unparalleled amounts of data.

# Network Data Rates

Sales of ethernet optical transceivers by Data Rate

(historical data and forecast)

**/ERY SMALL FORM FACTOR** 



Source: September 2022 Ethernet Optics Report



## **Traditional Solutions**

- Chassis systems with a density of 144f per 1RU
- Cassette-based systems with MPO to LC transitions
- MPO backbone cabling with BASE8/BASE12
- LC patch panels to connect duplex servers
- Multiple connection points for network access





#### Centralized Cross Connects

- Fast 'splice-free' connections with MPO
- Flexibility to mix and match connector type
- Modular 'pay as you grow' approach
- High-density with up to 144 fibers per 1RU
- Factory tested and guaranteed





# MPO-Based Applications





#### **MPO-Based Structured Cabling**





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# LC-Duplex Based Applications





#### **MPO-Based Structured Cabling**



#### **Poll Question 1**

What do you consider to be the most important aspect in building a future-proofed network?

- Reducing unnecessary connections to optimise link performance
- Maintaining granularity at the duplex level (lane shuffling)
- Building a more sustainable network
- Achieving the highest possible density
- Simplified network design for faster and easier maintenance



# VSFF Connectivity Overview





### VSFF Overview

Upgrade legacy networks



**SN**<sup>®</sup>

**SN®** Uniboot

**SN<sup>®</sup>-MT** 

- Transceiver Densification
- Direct Breakout
   Capability
- Transceiver Shuffling
- B2 Patch Panel Densification

- Backbone Trunk Optimization
- Inter-DC Trunk Optimization
- Base-8/Base-16 Patch
   Panel Densification
- CPO Switch Density



## VSFF Size Comparison



**MPO** 

7

Up to 3x denser than legacy connectors

10.7 mm



3.75 mm

**3** x

Denser



Denser



#### **VSFF Connector**

#### Duplex **SN**<sup>®</sup>



SN° 432F	Maximum Base-2 Density	The Law	200% Density Increase



#### SN<sup>®</sup> -MT16







# Transceiver Applications

- Transceiver Densification
- Direct Breakout Capability
- Transceiver Shuffling
- B2 Patch Panel Densification

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**Advanced Components** 

## **Centralized Shuffle Approach**





# Hardware Densification

**B2** Patch Panel Densification

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#### **Typical MPO-Based Structured Cabling**







72 CH

### Base-2 Upgrade





**SN**<sup>®</sup>







0007	10	111			
0000	0.5			0000 0000	
		with LC			

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### **SN**<sup>®</sup>*UNIBOOT* Sustainable Networks

Less plastic per connection and reduced hardware material

Improve air flow to equipment and reduce energy consumption

Increase capacity and reduce the need for additional data centers SN<sup>®</sup> connectors are less than half the size of an LC duplex connector

TITT



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%

**Reduction in** 

plastic

# SN Uniboot Compliment TO MPO





# **SN®UNBOOT**

## Connector

Backbone Trunk Optimization

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8 2

### Legacy vs. SN<sup>®</sup>



SN° 4-GANG

**BASE-8** 

*MPO-12* 





VS

BASE-8/Base-2







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#### **SN°** Base-8/2 Flexibility





1 x SN Gang-clipped (8-fibers) OR 1 x SN Uniboot (8-fibers)





#### Flexibility to meet the demands of today and tomorrow

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## **Eliminate Cassettes**

Triple the density, reduce cable clutter and accelerate network deployment

The SN-Uniboot is an 8-fiber, TELCO-Grade connector that enables 'Direct Breakout' capability at the front of patch panels without the need for cassettes or backbone MPO connectors. This unique functionality streamlines the network and delivers a higher degree of flexibility and performance.

**SN°** UNIBOOT

SN-Uniboot increases the density but eliminates unnecessary hard-

and greener a higher degree of flexibility and performance.

ware and connectivity. This makes networks faster, denser, leaner

#### MPO

#### **EVOLUTION**

SN Connectivity boosts the performance of legacy, cassette-based systems by increasing the density of the cassette by as much as three times.

#### REVOLUTION

#### Maximizing Transceiver Potential

SFP-DD

Supporting higher data rate optics

QSFP-DD :::

**Direct breakout flexibility** 



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#### **Poll Question 2**

What advantages do you see in deploying ceramic, duplex-based connectivity versus multi-fiber connectivity?

- Easier deployment and maintenance (polarity/gender)
- Lower loss
- Less impact of dust ingress on ferrule contact
- Increased flexibility with 2 fibers (smallest denominator)



# SN-MT Compliment TO MPO







## Uniboot Connectors





SENKO Products are RoHS, Reach SVHC and UL 94 V-0 compliant.





# **Connecting AI Clusters**



FIBER COUNT

**SN<sup>®</sup>-MT** 



#### Patching Options

Moving from MPO to **SN-MT** 





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#### **Poll Question 3**

What factors do you feel would influence the use of duplex transceivers at the higher data rates of say 400G and 800G?

- Fewer fibers between the transceivers (e.g 2 not 8)
- Easier connector to manage and maintain
- High availability of duplex connectivity
- Lower cost infrastructure
- Simplified network architecture



## **On-board Overview**

**More fibers** needed per switch ASIC

- MPO faceplate density Α
- VSFF faceplate density Β
- External Laser Source (ELSFP) С
- Mid-board connectors D
- Backplane connectors Ε
- Specialty fiber (PMF, small F diameter, bend insensitive, etc)
- MPC fiber-to-chip coupling (PIC) G



Advanced Con

### Learn More

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## **Contact Our Specialist**

#### Meet Adriana, your VSFF Product Specialist



#### Adriana Delgado

Senior Sales Account Manager





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